# Call for Papers

The 2<sup>nd</sup> International Symposium on Software Fault Prevention, Verification, and Validation (SFPVV 2025)

8 - 9 November 2025, Shanghai, China

HP: <a href="https://sfpvv2025.world/">https://sfpvv2025.world/</a>

#### **Important Dates**

#### Full/Regular Paper Track

Submissions: <u>25 August 2025</u>
Notification: <u>29 September 2025</u>
Camera-ready: <u>20 October 2025</u>

**Presentation Track** 

**Submissions:** <u>15 September 2025</u> **Notification:** <u>8 October 2025</u>

## **Symposium Organizers Steering Committee**

Tadashi Dohi Hiroshima University Shaoying Liu (Chair) East China Normal University Geguang Pu East China Normal University Tatsuhiro Tsuchiya University of Osaka

#### **General Chair**

Shaoying Liu

East China Normal University

### **Program Committee**

Yuting Chen (Chair)
Shanghai Jiaotong University
Hiroyuki Okamura (Chair)
Hiroshima University

\* Members are listed on the homepage

#### **Local Arrangement Chair**

Weikai Miao

East China Normal University

## Web and Registration Chairs

Min Zhang

East China Normal University Yuxiang Shang

Hiroshima University

## **Background and Objectives**

Software fault prevention, verification, and validation are essential and important approaches to ensuring software productivity, reliability, and qualities. Fault prevention focuses on the issues of how to prevent the introduction and occurrence of faults in software systems. Verification is a means to rigorously check whether software systems satisfy their specification or properties. Validation refers to the technologies and activities for confirming whether the behavior and performance of software systems satisfy the user's requirements. Various techniques and supporting tools have been developed to fulfill the tasks of software fault prevention, verification, and validation, but many difficulties and open problems remain unaddressed.

This symposium aims to invite researchers and practitioners working on software quality assurance to exchange ideas and to discuss how formal approaches, testing-based approaches, AI approaches, and their combinations can be studied, established, and supported to fulfill the goals of fault prevention, verification, and validation. All people who are interested in the topics mentioned above are welcome to submit papers and to participate in the symposium.

#### **Scope and Topics**

Authors are invited to submit technical papers describing original and unpublished work on, but not limited to, the following topics:

Specification and Prototyping Specification and Testing Refinement and Evolution Formal Verification and Review Testing-Based Formal Verification Bug Prediction and Reliability Modeling AI and Specification

AI and Code Generation
AI and Testing
AI and Verification
Human-Machine Pair Programming
Human-Machine Pair Review
Supporting Tools
Case studies
Application experience

#### **Submission and Publication**

Two types of submissions are possible: **presentation papers** and **regular papers**. Both types of papers should be written in English. All papers should be submitted using the EasyChair link: <a href="https://easychair.org/conferences/?conf=sfpvv2025">https://easychair.org/conferences/?conf=sfpvv2025</a> Accepted presentation papers will not be included in the proceedings of the symposium; only the accepted regular papers will be included in the proceedings, which will be published in the Springer LNCS series. The details of the symposium can be found in the symposium homepage.

- A regular paper must not have been published or be concurrently considered for publication elsewhere. Each regular paper should not exceed
   18 pages (including references) in the Springer LNCS format.
- A presentation paper is not required to report mature research results but
  expected to include new ideas or progress in ongoing research projects. Each
  presentation paper must provide a clear title and an extended abstract in 2
  pages in the Springer LNCS format.

## Cooperation

East China Normal University, China Hiroshima University, Japan